LTE Full-Band Ceramic Chip Antenna

Features

- Supporting LTE full-band/3G/2G
- Stable and reliable performance
- Compact Size
- SMT processes compatible
- RoHS Compliant

Applications

- LTE full-band/3G/2G
- LTE/ GSM/ CDMA/ DCS/ PCS/ WCDMA/ UMTS/ HSDPA / GPRS / EDGE / IMT

Specifications

Electrical

| Frequency Range (MHz) | 698 ~798 | 824~960 | 1710~2170 | 2300~2400 | 2490 ~2690 |
|-----------------------|---|---------|-----------|-----------|------------|
| Peak Gain (dBi) typ. | 1.3 dBi | 1.0 dBi | 2.6 dBi | 4.4 dBi | 4.2 dBi |
| Efficiency (%) typ. | 54% | 58% | 55% | 75% | 65% |
| VSWR | <3.5 : 1 | | | | |
| Maximum Input Power | 5 W | | | | |
| Polarization | Linear | | | | |
| Impedance | 50Ω | | | | |
| Environmental | | | | | |
| Operating Temperature | -40°C~+85°C | | | | |
| Storage Temperature | -5°C~+40°C -40°C~+85°C - After mounting on PCB | | | | |
| Relative Humidity | 10% to 70% - Operating & Storage after mounting on PCB 20% to 70% - Storage | | | | |
| Shelf Life | 1 year | | | | |
| RoHs Compliant | Yes | | | | |



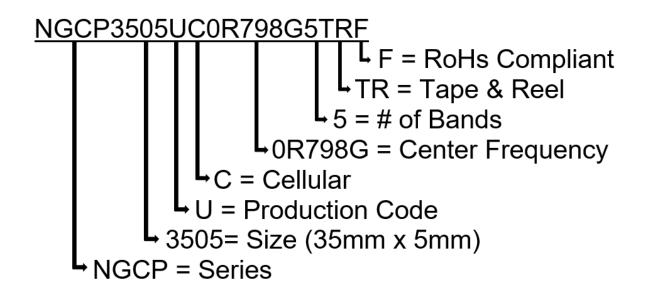




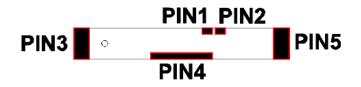
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Part Number Breakdown



Pin Definition



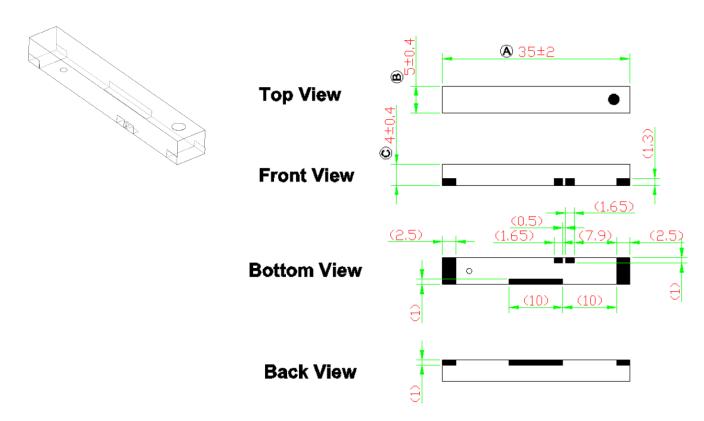
Bottom View

| PIN | 1 | 2 | 3~5 |
|---------------|---------------|--------|-----|
| Soldering Pad | Tuning/Ground | Signal | N/C |

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Dimension Drawing



Dimensions (mm) & Mechanical

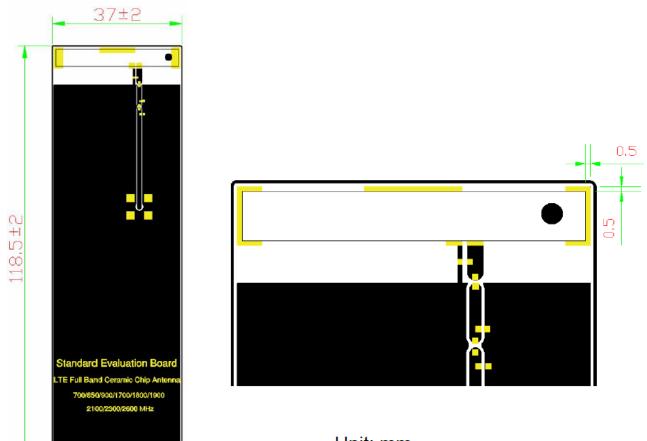
| Body Length (A) | 35 ± 2 |
|-----------------|------------------|
| Width (B) | 5 ± 0.4 |
| Thickness (C) | 4 ± 0.4 |
| Connection Type | SMT |
| Ground Plane | 118.5 mm x 37 mm |
| Material | Ceramic |

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Evaluation Board



Unit: mm

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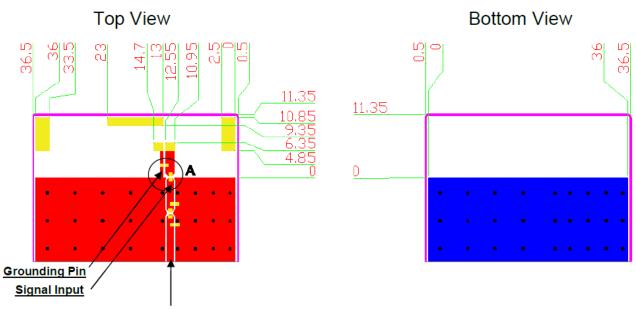
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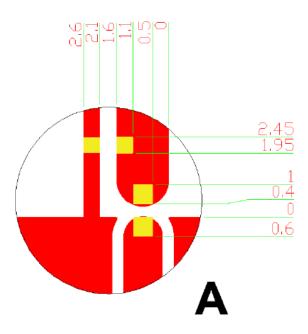


Solder Land Pattern

The gold areas represent the solder land pattern. Any recommendations on the matching circuit will be provided according to the customer's installation conditions.



Transmission Line with 50Ω Impedance Characteristic

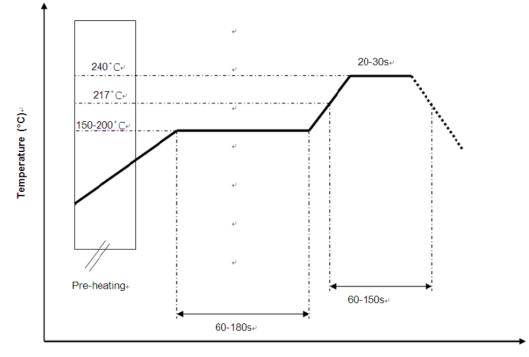


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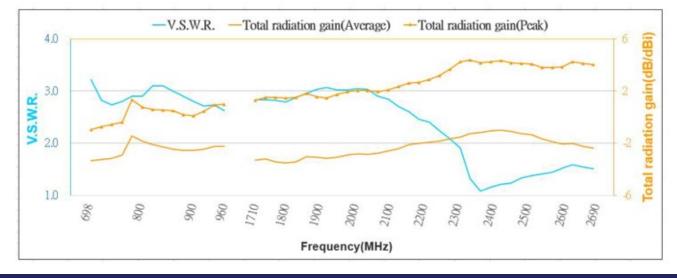
Soldering Conditions



Time (s.)₽

*Recommended solder paste alloy: SAC305 (Sn96.5 /Ag3 /Cu0.5) Lead Free solder paste.

Frequency vs. VSWR and Total Radiation Gain



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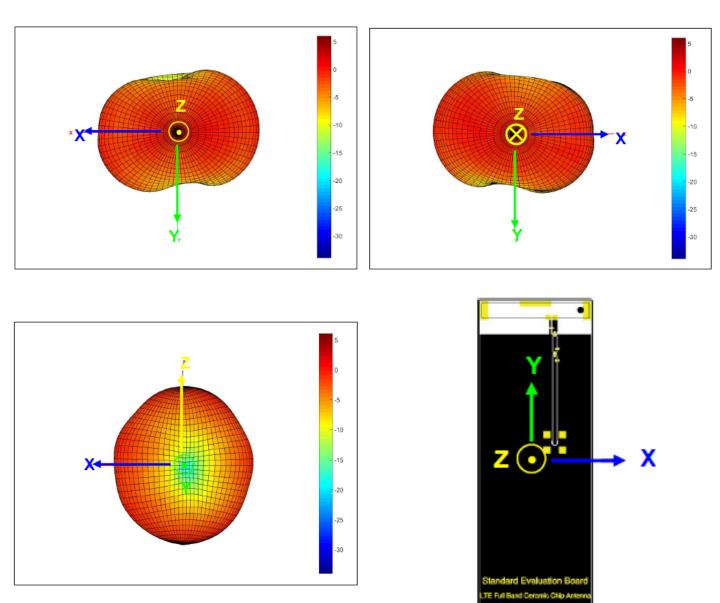
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3D Radiation Gain Pattern:

698~798 MHz Band @ 748 MHz (unit: dBi)

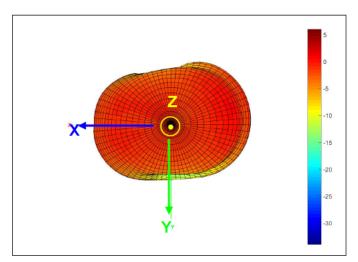


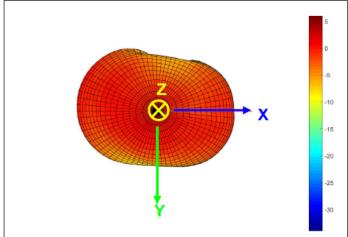
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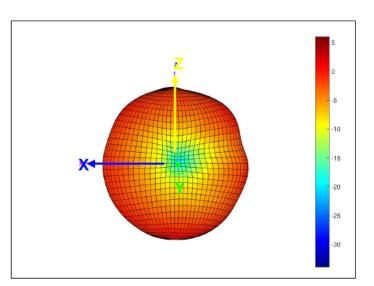
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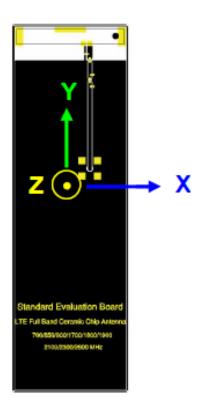


824~960MHz Band @ 890 MHz (unit: dBi)









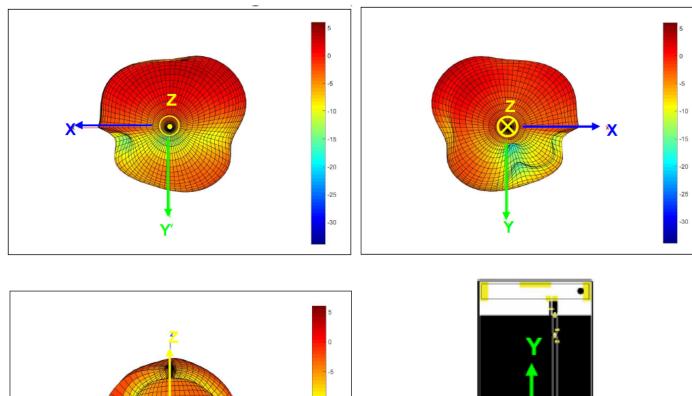
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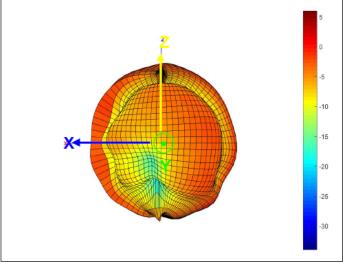
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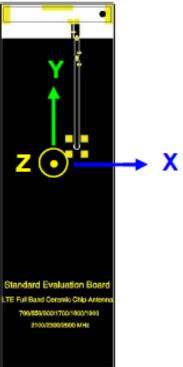
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1710 ~ 2170 MHz Band @ 1950 MHz (unit: dBi)







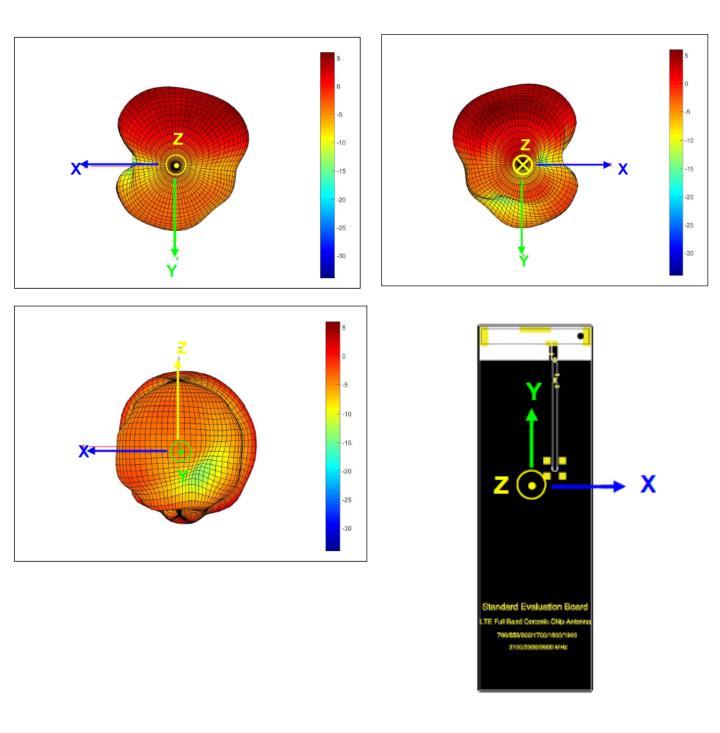
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2300 ~ 2400 MHz Band @ 2350 MHz (unit: dBi)



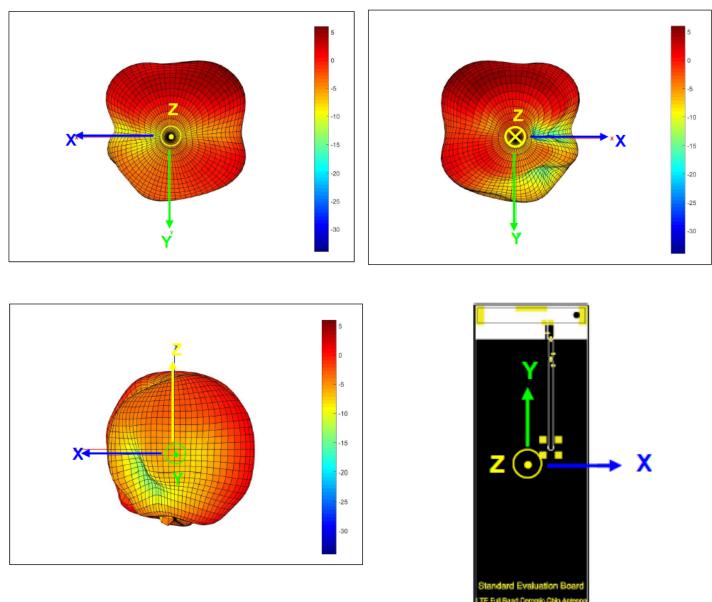
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2490 ~ 2690 MHz Band @ 2590 MHz (unit: dBi)



700/850/900/1700/1800/1940 2100/2500/2600 MHz

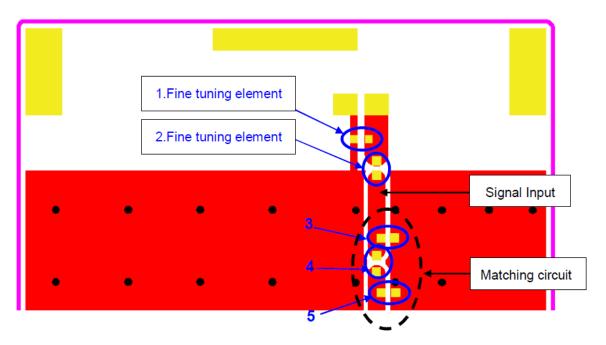
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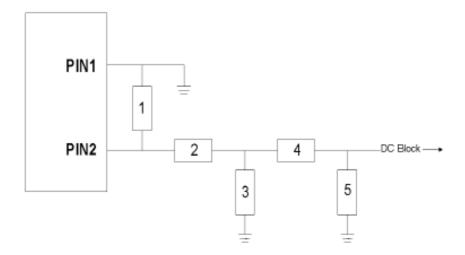
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Frequency Tuning & Matching Circuit





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| System Matching Circuit Component | | | | |
|-----------------------------------|---------------|-----------|------------------------|--|
| Location | Description | Tolerance | NIC Part Number | |
| 1 | 6.8 nH (0402) | ±2% | NML04G6N8TRF | |
| 2 | 3.9pF, (0402) | ±0.05 | NMC-Q0402NPO3R9A50TRPF | |
| 3 & 5 | - | - | - | |
| 4 Fine Tuning Elements | 0 Ω, (0402) | - | NRC04Z0TRF | |

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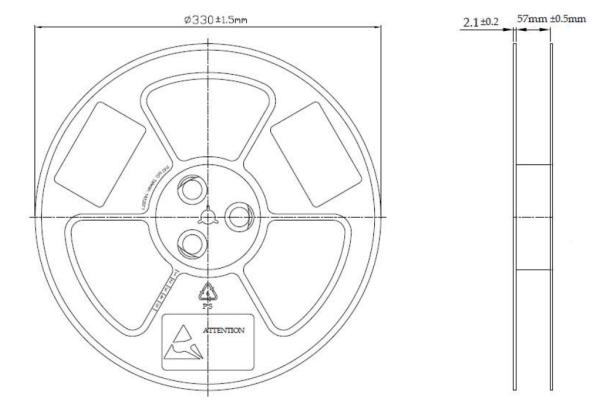
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Packing

- (1) Quantity / Reel: 1000 pcs / Reel
- (2) Plastic tape: Clear Non Anti-static Polystyrene
- (3) Weight: 1 pcs = 2.3 g typ.

1 Reel = 3 Kg typ.



a. Reel Dimensions

ISC

9001:2015 CERTIFIED ROHS/REACH

COMPLIANT ALOGEN FREE

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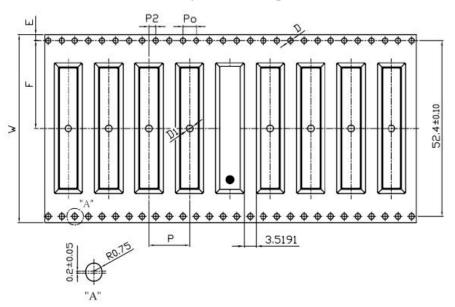
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b. Tape Drawing



c. Tape Dimensions

| Feature | Specifications | Tolerances |
|---------|----------------|------------|
| W | 56.00 | ±0.30 |
| Р | 12.00 | ±0.10 |
| E | 1.75 | ±0.10 |
| F | 26.20 | ±0.15 |
| P2 | 2.00 | ±0.15 |
| D | 1.50 | +0.10 |
| D | 1.50 | -0.00 |
| D1 | 2.00 | ±0.10 |
| Ро | 4.00 | ±0.10 |
| 10Po | 40.00 | ±0.20 |

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